



# CIRTEK ELECTRONICS CORPORATION

116 East Avenue, Phase V, SEZ Laguna Technopark  
Binan, Laguna, Philippines

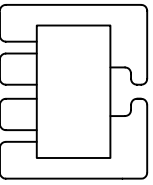
## PRODUCT INFORMATION

Customer :	Device ID :
Die Size :	Water Material :
Die Size :	No. of Wires :
Package Type : 3L SOT89	

## MATERIAL INFORMATION

Leadframe : PMCG90 1/2H with spot Ag	Pad Size : 75x70 mils
Epoxy :	Gold Wire :
Molding Compound :	Lead Finish :

## MARKING INSTRUCTION

TOP : 	BOTTOM : n/a
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BONDING DIAGRAM NO.

REF. BONDING DIAGRAM NO.

SCALE  
not scale

DRAWN BY: \_\_\_\_\_ REVIEWED BY: \_\_\_\_\_

### REVISION NO.

### APPROVALS

REV. #	DESCRIPTION	PCN #	DEPT	APPROVALS	DATE
			CUST		
			QSM		
			QC		
			MFG		

SPECIAL INSTRUCTIONS:

